



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Per Møller
Serial No. : 10/529,467
Filed : March 28, 2005
For : METHOD FOR PRETREATING A SURFACE OF A NON-
CONDUCTING MATERIAL TO BE PLATED
Group A. U. : 1775
Conf. No. : 8292
Examiner : Michael E. Lavilla

I hereby certify that this paper is being deposited this date with the
U.S. Postal Service in first class mail addressed to Commissioner
for Patents, P.O. Box 1450, Alexandria, VA 22123-1450.

Richard F. Jaworski *May 4, 2007*
Richard F. Jaworski Date
Reg. No. 33,515

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Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

AMENDMENT AFTER FINAL REJECTION

In response to the final Office Action dated December 4, 2006, the time for
responding to which having been extended to May 4, 2007 by the accompanying two
month Petition For Extension of Time, please amend the above-identified application as
follows:

Amendments to the claims are reflected in the listing of claims that begins on
page 3 of this paper.

Remarks begin on page 6 of this paper.

*do not
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me
5/16/07*